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10/589,399	08/14/2006	Guo-Quan Lu	124617.00118	7126
27557 BLANK ROMI	7590 07/10/200 E LLP	EXAMINER		
WATERGATE			TAKEUCHI, YOSHITOSHI	
600 NEW HAN WASHINGTO	IPSHIRE AVENUE, N N, DC 20037	N.W.	ART UNIT	PAPER NUMBER
			1793	
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			07/10/2009	PAPER

# Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)			
	10/589,399	LU ET AL.			
Office Action Summary	Examiner	Art Unit			
	YOSHITOSHI TAKEUCHI	1793			
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address			
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period w.  - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim vill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	lely filed the mailing date of this communication. (35 U.S.C. § 133).			
Status					
1) ☐ Responsive to communication(s) filed on 15 Ag  2a) ☐ This action is <b>FINAL</b> . 2b) ☐ This  3) ☐ Since this application is in condition for allowar closed in accordance with the practice under E	action is non-final. nce except for formal matters, pro				
Disposition of Claims					
4) Claim(s) 1-20 is/are pending in the application.  4a) Of the above claim(s) is/are withdrav  5) Claim(s) is/are allowed.  6) Claim(s) 1-20 is/are rejected.  7) Claim(s) is/are objected to.  8) Claim(s) are subject to restriction and/or  Application Papers  9) The specification is objected to by the Examine 10   X   The drawing(s) filed on 14 August 2006 is/are:	vn from consideration.  r election requirement. r.	o by the Examiner			
<ul> <li>10) ☐ The drawing(s) filed on 14 August 2006 is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.         Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).         Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).</li> <li>11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.</li> </ul>					
Priority under 35 U.S.C. § 119					
<ul> <li>12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>					
Attachment(s)  1) Notice of References Cited (PTO-892)  2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date 15 April 2009.	4)  Interview Summary Paper No(s)/Mail Da 5)  Notice of Informal P 6)  Other:	ite			

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#### **DETAILED ACTION**

### Claim Rejections - 35 USC § 103

1. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

- 2. Claims 1-3 and 5-13 are rejected under 35 U.S.C. 103(a) as obvious over Basol (US 2004/0219730).
  - a. Regarding claims 1-3, Basol teaches a composition (abstract) comprising: a silver nano-powder composed of a plurality of silver (¶ 0041) particles of a particle size of less than about 200 nm, and preferably less than about 100 nm (¶ 0035); a dispersant associated with particles of the metal or metal alloy powder (¶ 0036), said dispersant being present in sufficient quantity to reduce or prevent agglomeration of said particles of the metal or metal alloy powder (presumed, since that is the function of a dispersant); and a binder having a temperature of volatilization below the sintering temperature of said metal or metal alloy powder (¶ 0037).

Basol does not expressly teach a method "for forming an interconnect," but it would have been obvious to a person of ordinary skill at the time of the invention to use the method of Basol to make an interconnect because Basol teaches a method of adding a thin layer of metallic nano-particles for electrical devices, where adding a thin layer of metallic nano-particles would be advantageous to minimize the size of an interconnect.

b. Regarding claim 5, Basol teaches the composition of claim 1, wherein said binder is a polymeric material (¶ 0038, a polymeric material implied from, the teaching that the

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binder be preferably a "volatile material that once evaporated out of the wet micro-layer, leaves substantially no residue behind that would have deleterious effect").

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c. Regarding claim 6, Basol teaches the composition of claim 1 further comprising a carrier, which would adjust the viscosity of the composition (¶ 0038).

d. Regarding claims 7, 10 and 12, Basol teaches a method comprising the step of: sintering (¶ 0040) silver (¶ 0041) particles of a particle size of less than about 200 nm, and preferably less than about 100 nm (¶ 0035), which are positioned on contacts on the device and the substrate (¶ 0009 and Figure 4, item 42) and sandwiched therebetween; and said sintering step forming a metal or metal alloy layer from said metal or metal alloy particles (abstract).

Basol does not expressly teach a method "for forming an interconnect which performs at least one of mechanically, thermally or electrically connecting a device to a substrate," but it would have been obvious to a person of ordinary skill at the time of the invention to use the method of Basol to make an interconnect because Basol teaches a method of adding a thin layer of metallic nano-particles for electrical devices, where adding a thin layer of metallic nano-particles would be advantageous to minimize the size of an interconnect.

- e. Regarding claim 8, Basol teaches the method of claim 7 further comprising the step of depositing on at least one electrical contact of at least one of the device and the substrate said metal or metal alloy particles (Figure 4 and ¶ 0030).
- f. Regarding claim 9, Basol teaches the method of claim 8 wherein said step of depositing is performed by screening, printing or stenciling ( $\P$  0037).

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g. Regarding claim 11, Basol teaches the method of claim 7 further comprising the step of holding the device and the substrate together during the step of sintering (presumed since the two are kept together. Natural forces, such as gravity, would hold the two together).

Alternatively, it would have been obvious to hold the device and substrate together during sintering to provide the desired adhesion (i.e. avoid shifting) of the device and the substrate.

h. Regarding claim 13, Basol teaches the method of claim 7 wherein said metal or metal alloy, prior to said step of sintering, is present in the form of a paste which comprises a dispersant associated with the metal or metal alloy particles, said dispersant being present in sufficient quantity to reduce or prevent agglomeration of said metal or metal alloy particles, and a binder having a temperature of volatilization below the sintering temperature of said metal or metal alloy particles (¶ 0036-37).

#### Claim Rejections - 35 USC § 103

- 3. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.
- 4. Claims 4 and 14-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Basol (US 2004/0219730) in view of Kodas et al (US 2003/0108644).
  - a. Regarding claim 4, Basol teaches the composition of claim 1, wherein the dispersant be a well-known dispersants ( $\P$  0036), but does not teach the dispersant being a fatty acid or a fish oil

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Kodas teaches a method for forming recessed electrical features, such as interconnects, using silver nano-particles (abstract). Kodas uses fish oil as a dispersant (¶ 0260).

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As a result, it would have been obvious to a person of ordinary skill at the time of the invention to use the fish oil, as taught by Kodas, as the dispersant of Basol, because Basol taught the use of any well-known dispersant (¶ 0036-37) and Kodas teaches fish oil is known as a type of dispersant.

b. Regarding claims 14-16 and 18, Basol teaches a method comprising the step of: positioning a paste which comprises a silver (¶ 0041) powder composed of a plurality of particles of a particle size of less than about 200 nm, and preferably less than about 100 nm (¶ 0035); dispersant associated with particles of the metal or metal alloy powder (¶ 0036), said dispersant being present in sufficient quantity to reduce or prevent agglomeration of said particles of the metal or metal alloy powder (presumed, since that is the function of a dispersant); a binder having a temperature of volatilization below the sintering temperature of said metal or metal alloy powder (¶ 0037); heating said paste to a temperature and for a time sufficient to remove said binder and said dispersant (¶ 0038, a polymeric material implied from, the teaching that the binder be preferably a "volatile material that once evaporated out of the wet micro-layer, leaves substantially no residue behind that would have deleterious effect"); and to sinter metal particles of said metal or metal alloy powder together to form a metal or metal alloy layer from said metal or metal alloy particles which performs at least one of mechanically, thermally, or electrically interconnecting the device and the substrate ( $\P$  0040).

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Kodas teaches a paste for connecting a substrate and a device (¶ 360) and also positioning said paste between contacts of said substrate and said device (¶ 360)

- c. Regarding claim 17, Basol teaches the method of claim 14 wherein said positioning step is performed by stenciling, printing, or screening (¶ 0037).
- d. Regarding claims 19-20, Basol teaches the method of claim 14 further comprising the step of isolating said metal or metal alloy particles with said binder until a preset temperature during said heating step, wherein said preset temperature is determined based on said binder and a sintering temperature for said metal or metal alloy particles, wherein said preset temperature is the same as or slightly below a sintering temperature for said metal or metal alloy particles (¶ 0040).

## Response to Arguments

5. Applicant's arguments with respect to claims 1-20 have been considered but are moot in view of the new ground(s) of rejection.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to YOSHITOSHI TAKEUCHI whose telephone number is (571) 270-5828. The examiner can normally be reached on Monday-Thursday 9:30-3:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Dr. Roy King can be reached on (571) 272-1244. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated

information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Roy King/ Supervisory Patent Examiner, Art Unit 1793

/YOSHITOSHI TAKEUCHI/ Examiner, Art Unit 1793